

## SNUBBERLESS TRIAC

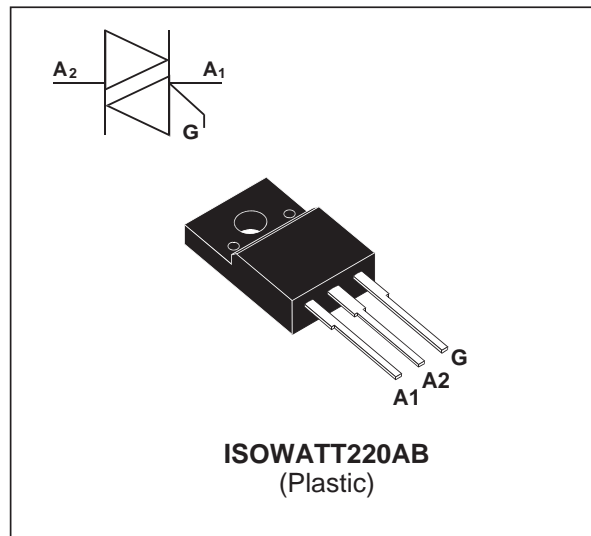
### FEATURES

- $I_{T(RMS)} = 6A$
- $V_{DRM} = V_{RRM} = 600V$
- EXCELLENT SWITCHING PERFORMANCES
- INSULATING VOLTAGE =  $1500V_{(RMS)}$
- U.L. RECOGNIZED : E81734

### DESCRIPTION

The T620-600W and T630-600W triacs use high performance glass passivated chip technology, housed in a fully molded plastic ISOWATT220AB package.

The SNUBBERLESS™ concept offers suppression of R-C network, and is suitable for applications such as phase control and static switch on inductive and resistive loads.



### ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
$I_{T(RMS)}$	RMS on-state current (360° conduction angle)	$T_c = 100^\circ C$	6	A
$I_{TSM}$	Non repetitive surge peak on-state current ( $T_j$ initial = $25^\circ C$ )	$t_p = 16.7$ ms (1 cycle, 60 Hz)	66	A
		$t_p = 10$ ms (1/2 cycle, 50 Hz)	75	
$I^2t$	$I^2t$ Value (half-cycle, 50 Hz)	$t_p = 10$ ms	28	$A^2s$
$di/dt$	Critical rate of rise of on-state current Gate supply : $I_G = 500$ mA $di_G/dt = 1$ A/ $\mu s$ .	Repetitive F = 50 Hz	20	A/ $\mu s$
		Non Repetitive	100	
$T_{stg}$ $T_j$	Storage temperature range		- 40 to + 150	$^\circ C$
	Operating junction temperature range		- 40 to + 125	
TI	Maximum lead temperature for soldering during 10s at 4.5 mm from case		260	$^\circ C$

Symbol	Parameter	Value	Unit
$V_{DRM}$ $V_{RRM}$	Repetitive peak off-state voltage $T_j = 125^\circ C$	600	V

## T620-600W / T630-600W

### THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
Rth(j-a)	Junction to ambient	50	°C/W
Rth(j-c)	Junction to case for A.C (360° conduction angle)	3.4	°C/W

### GATE CHARACTERISTICS (maximum values)

$P_{G(AV)} = 1 \text{ W}$   $P_{GM} = 10 \text{ W}$  ( $t_p = 20 \mu\text{s}$ )  $I_{GM} = 4 \text{ A}$  ( $t_p = 20 \mu\text{s}$ )

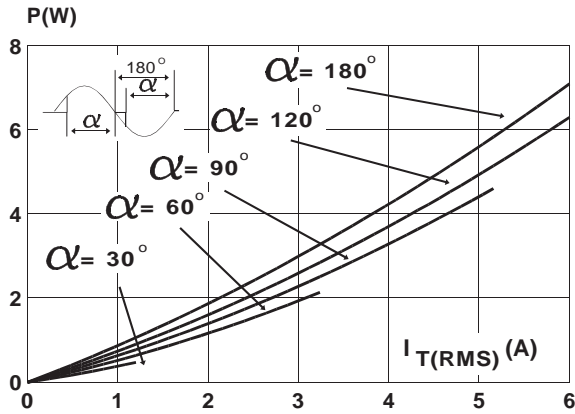
### ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions	Quadrant		T620	T630	Unit	
$I_{GT}$	$V_D = 12\text{V (DC)}$ $R_L = 33\Omega$	$T_j = 25^\circ\text{C}$	I-II-III	MAX	20	30	mA
$V_{GT}$	$V_D = 12\text{V (DC)}$ $R_L = 33\Omega$	$T_j = 25^\circ\text{C}$	I-II-III	MAX	1.5		V
$V_{GD}$	$V_D = V_{DRM}$ $R_L = 3.3\text{k}\Omega$	$T_j = 125^\circ\text{C}$	I-II-III	MIN	0.2		V
tgt	$V_D = V_{DRM}$ $I_G = 500\text{mA}$ $dI_G/dt = 3\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$	I-II-III	TYP	2		$\mu\text{s}$
$I_H^*$	$I_T = 100\text{mA}$ Gate open	$T_j = 25^\circ\text{C}$		MAX	35	50	
$V_{TM}^*$	$I_{TM} = 8.5\text{A}$ $t_p = 380\mu\text{s}$	$T_j = 25^\circ\text{C}$		MAX	1.5		V
$I_{DRM}$ $I_{RRM}$	VDRM rated VRRM rated	$T_j = 25^\circ\text{C}$		MAX	10		$\mu\text{A}$
		$T_j = 125^\circ\text{C}$		MAX	2		mA
dV/dt *	Linear slope up to $V_D = 67\%V_{DRM}$ Gate open	$T_j = 125^\circ\text{C}$		MIN	200	300	V/ $\mu\text{s}$
(dV/dt)c *	(dI/dt)c = 3.3 A/ms (see note)	$T_j = 125^\circ\text{C}$		MIN	10	20	V/ $\mu\text{s}$

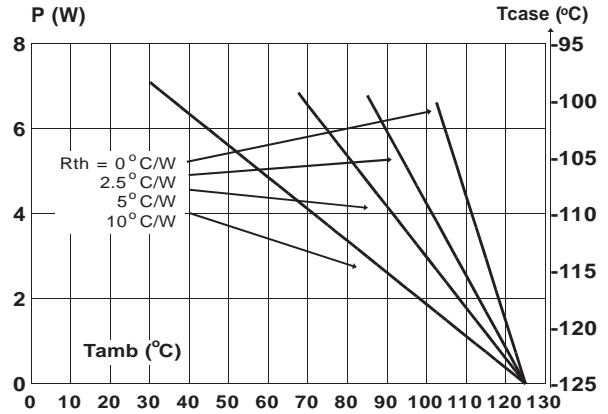
\* For either polarity of electrode A2 voltage with reference to electrode A1.

**Note** : In usual applications where (dI/dt)c is below 3.3 A/ms, the (dV/dt)c is always lower than 10V/ $\mu\text{s}$ , and, therefore, it is **unnecessary** to use a snuber R-C network across T620W / T630W triacs.

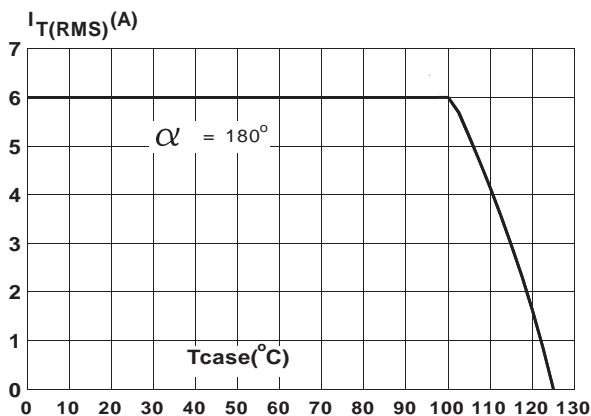
**Fig.1** : Maximum power dissipation versus RMS on-state current.



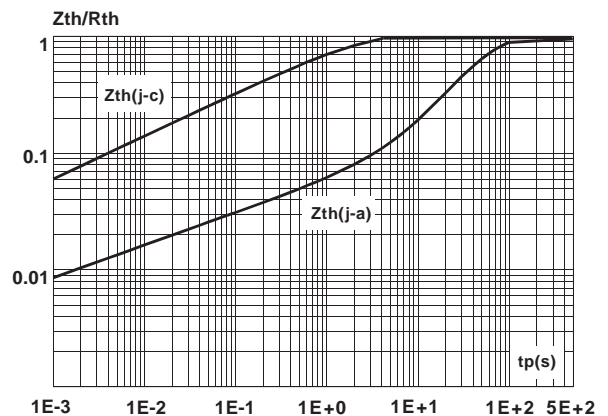
**Fig.2** : Correlation between maximum power dissipation and maximum allowable temperature (Tamb and Tcase) for different thermal resistances heatsink + contact.



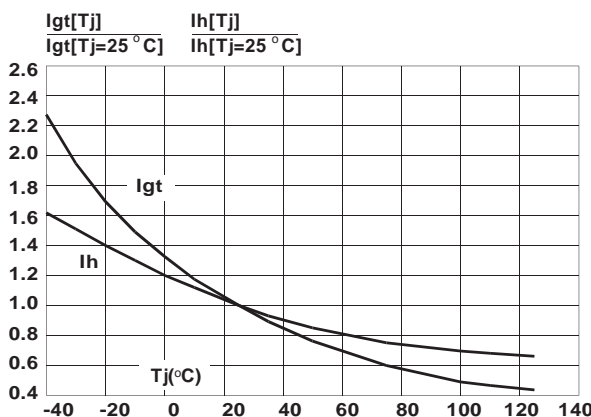
**Fig.3** : RMS on-state current versus case temperature.



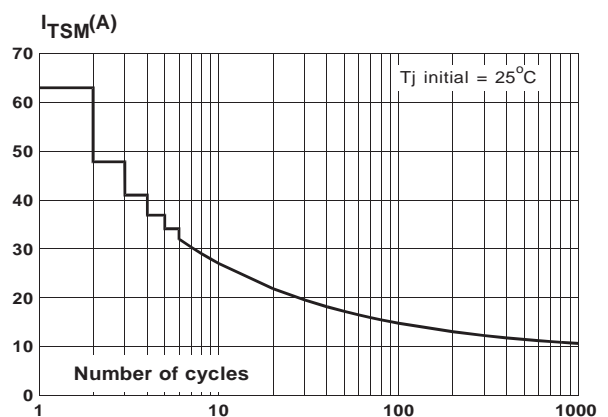
**Fig.4** : Thermal transient impedance junction to case and junction to ambient versus pulse duration.



**Fig.5** : Relative variation of gate trigger current and holding current versus junction temperature.

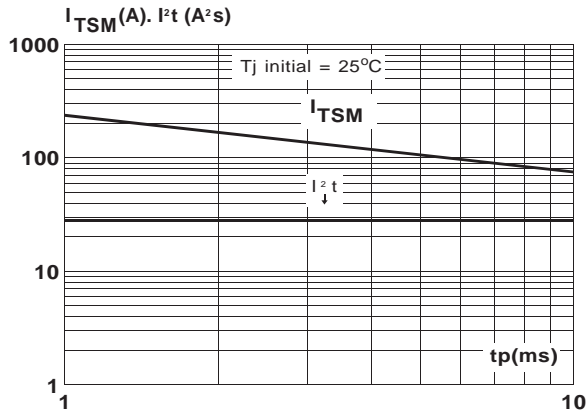


**Fig.6** : Non repetitive surge peak on-state current versus number of cycles.

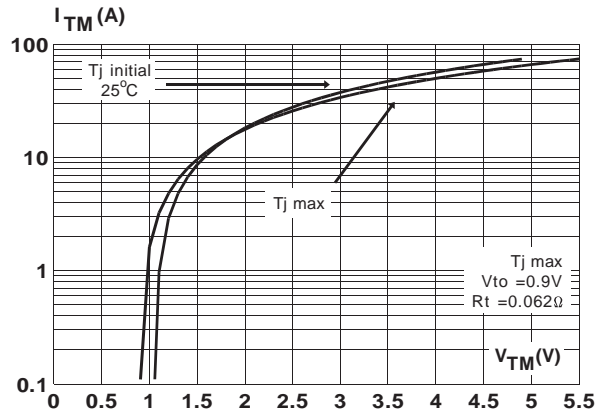


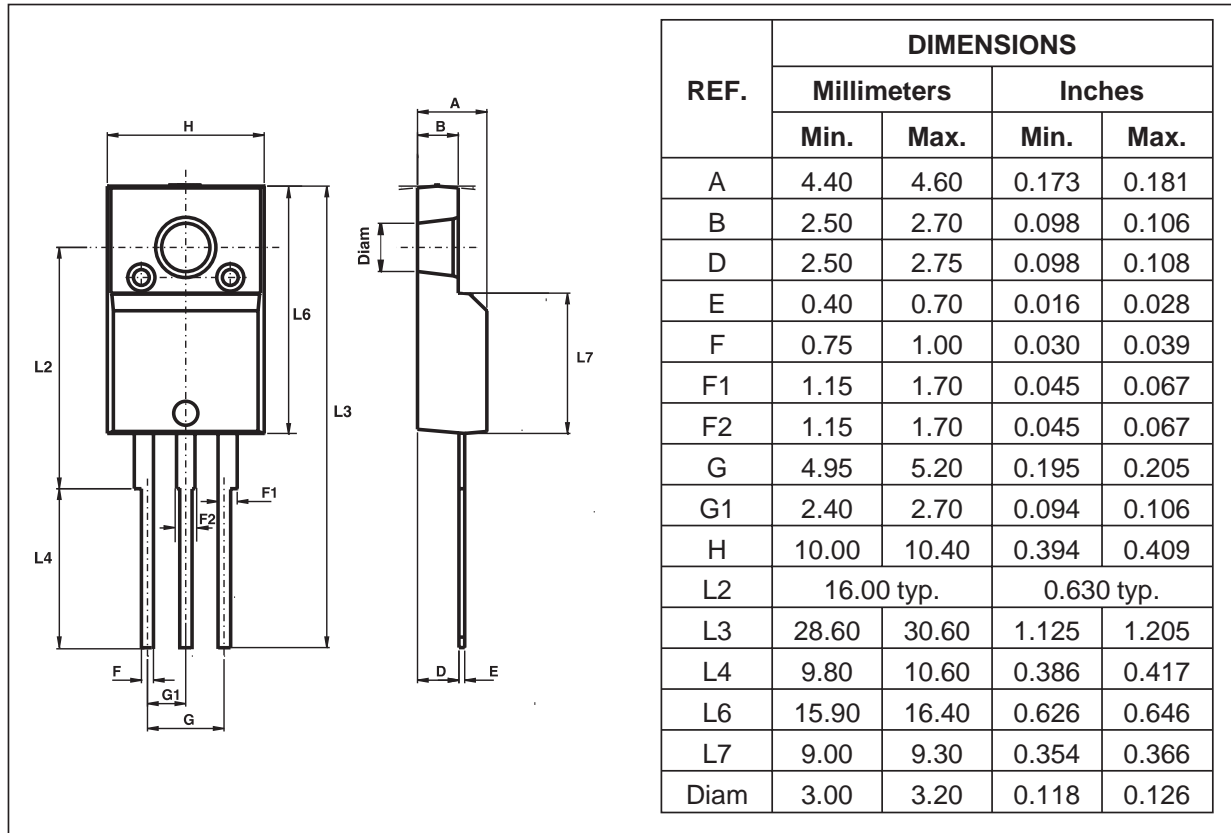
**T620-600W / T630-600W**

**Fig.7 :** Non repetitive surge peak on-state current for a sinusoidal pulse with width :  $t_p @ 10ms$ , and corresponding value of  $I^2t$ .



**Fig.8 :** On-state characteristics (maximum values).



**PACKAGE MECHANICAL DATA**  
 ISOWATT220AB


- Cooling method : C
- Marking : Type number
- Weight : 2.1g
- Recommended torque value : 0.55 m.N.
- Maximum torque value : 0.70 m.N.

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